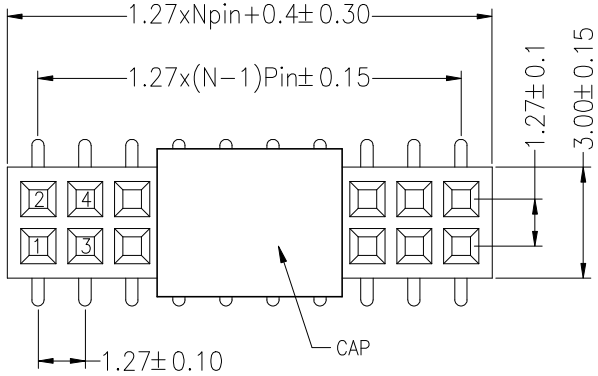
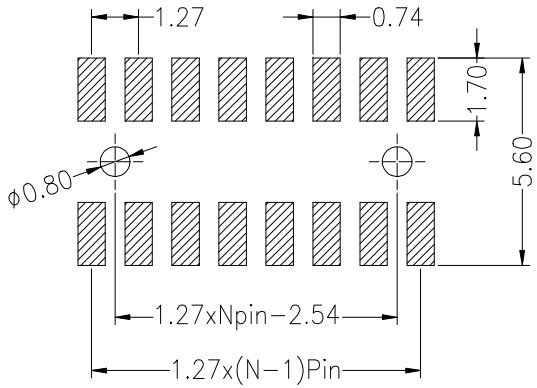
HSF RoHS FILE NO :E362810

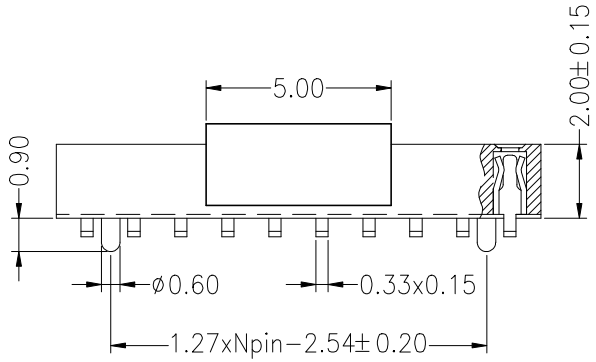
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

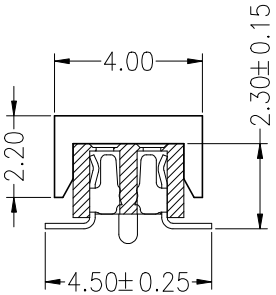
Contact Material:Phosphor Bronze
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Soldering temperature: 260°C±5° 5S



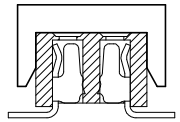
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)







W= With Post



N= W/O Post

Ordering Information

2420 02 XX X X XX M U X 0X

No.of Pins Per Row 2~50	Insulator Material Option C=BK-PA6T E=BK-PA9T F=BK-LCP	Post W=With Post N=W/O Post	Contact Plating G1:Gold Flash G3:2U" Gold G4:3U" Gold G5:5U" Gold G6:10U" Gold G7:15U" Gold S0:Gold Flash/Tin SN:Tin

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2020.04.18	NEW DRAWING	

OPERATION		DRAW	Liu Miao	20.04.18
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	242002XXXXXXMUX0X
TITLE:	1.27PF 2xNPin H2.0 SMT